

# DATA SHEET

**MC1408-8**

**8-bit multiplying D/A converter**

Product data  
Supersedes data of 1994 Aug 31  
File under Integrated Circuits, IC11 Handbook

2001 Aug 03

# 8-bit multiplying D/A converter

# MC1408-8

## DESCRIPTION

The MC1408-8 is an 8-bit monolithic digital-to-analog converter which provides high-speed performance with low cost. It is designed for use where the output current is a linear product of an 8-bit digital word and an analog reference voltage.

## FEATURES

- Fast settling time: 70 ns (typ)
- Relative accuracy  $\pm 0.19\%$  (max error)
- Non-inverting digital inputs are TTL and CMOS compatible
- High-speed multiplying rate 4.0 mA/ $\mu$ s (input slew)
- Output voltage swing +0.5 V to -5.0 V
- Standard supply voltages +5.0 V and -5.0 V to -15 V

## APPLICATIONS

- Tracking A-to-D converters
- 2 1/2-digit panel meters and DVMs
- Waveform synthesis
- Sample-and-Hold
- Peak detector
- Programmable gain and attenuation
- CRT character generation
- Audio digitizing and decoding
- Programmable power supplies
- Analog-digital multiplication
- Digital-digital multiplication
- Analog-digital division
- Digital addition and subtraction
- Speech compression and expansion
- Stepping motor drive modems
- Servo motor and pen drivers

## PIN CONFIGURATIONS

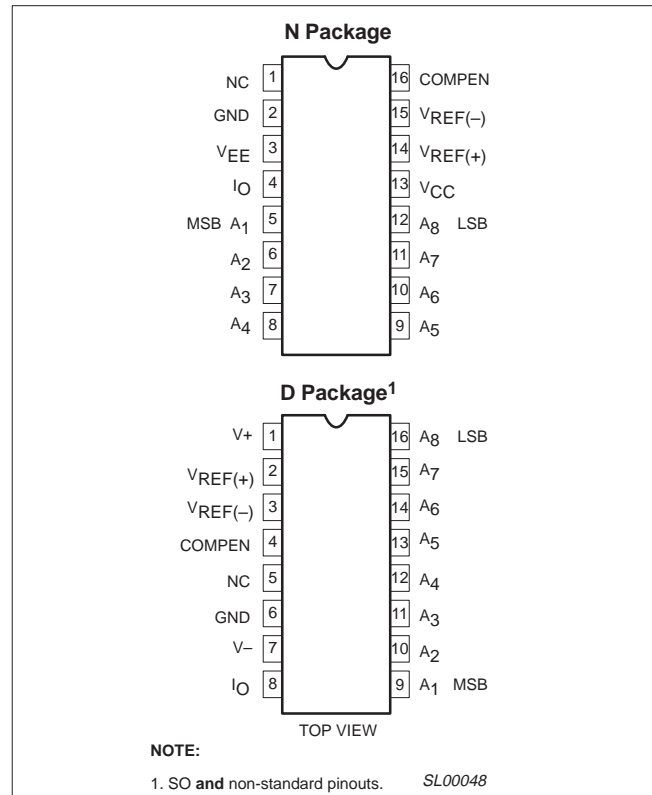


Figure 1. Pin Configurations

## ORDERING INFORMATION

DESCRIPTION	TEMPERATURE RANGE	ORDER CODE	DWG #
16-Pin Plastic Dual In-Line Package (DIP)	0 °C to +70 °C	MC1408-8N	SOT38-4
16-Pin Small Outline (SO) Package	0 °C to +70 °C	MC1408-8D	SOT109-1

# 8-bit multiplying D/A converter

MC1408-8

## BLOCK DIAGRAM

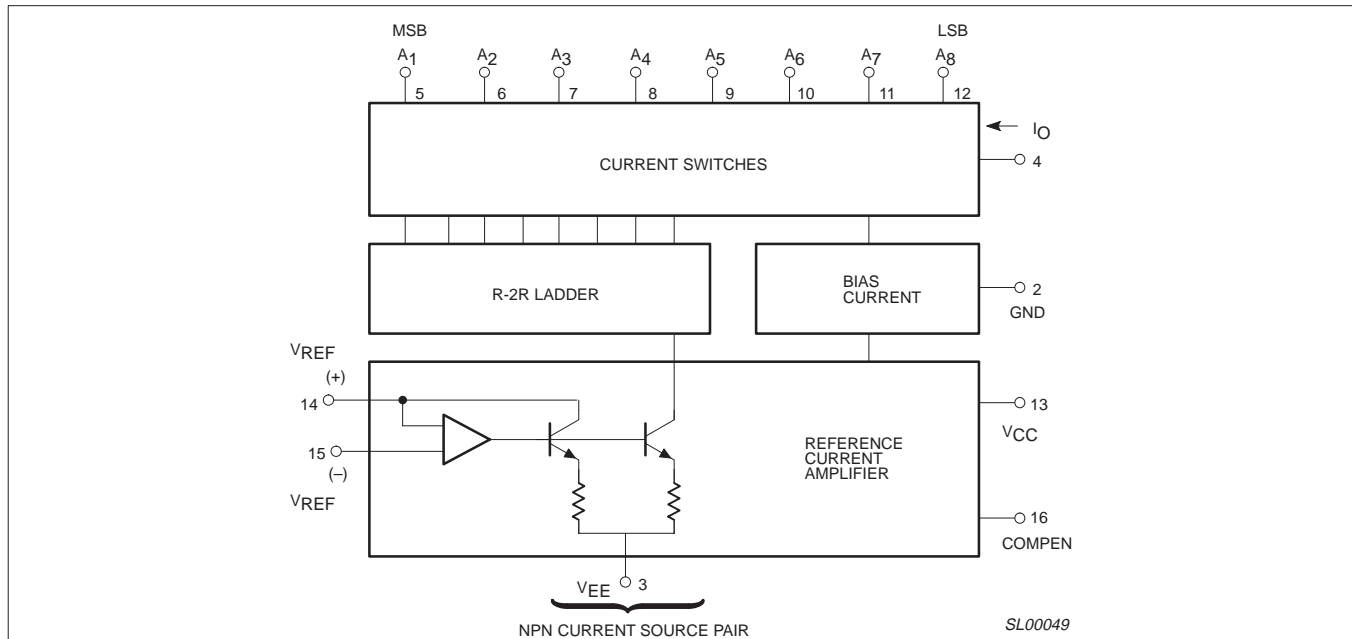


Figure 2. Block Diagram

## CIRCUIT DESCRIPTION

The MC1408-8 consists of a reference current amplifier, an R-2R ladder, and 8 high-speed current switches. For many applications, only a reference resistor and reference voltage need be added.

The switches are non-inverting in operation; therefore, a high state on the input turns on the specified output current component.

The switch uses current steering for high speed, and a termination amplifier consisting of an active load gain stage with unity gain

feedback. The termination amplifier holds the parasitic capacitance of the ladder at a constant voltage during switching, and provides a low impedance termination of equal voltage for all legs of the ladder.

The R-2R ladder divides the reference amplifier current into binary-related components, which are fed to the remainder current which is equal to the least significant bit. This current is shunted to ground, and the maximum output current is 255/256 of the reference amplifier current, or 1.992 mA for a 2.0 mA reference amplifier current if the NPN current source pair is perfectly matched.

## ABSOLUTE MAXIMUM RATINGS

SYMBOL	PARAMETER	RATING	UNIT
V <sub>CC</sub>	Positive power supply voltage	+5.5	V
V <sub>EE</sub>	Negative power supply voltage	-16.5	V
V <sub>5</sub> - V <sub>12</sub>	Digital input voltage	0 to V <sub>CC</sub>	V
V <sub>O</sub>	Applied output voltage	-5.2 to +18	V
I <sub>14</sub>	Reference current	5.0	mA
V <sub>14</sub> , V <sub>15</sub>	Reference amplifier inputs	V <sub>EE</sub> to V <sub>CC</sub>	
P <sub>D</sub>	Maximum power dissipation, T <sub>amb</sub> = 25 °C (still-air) <sup>1</sup>	1450 1080	mW mW
T <sub>amb</sub>	Operating temperature range	0 to +75	°C
T <sub>stg</sub>	Storage temperature range	-65 to +150	°C
T <sub>sld</sub>	Lead soldering temperature (10 sec)	+230	°C

### NOTES:

- Derate above 25°C, at the following rates:  
N package at 11.6 mW/°C;  
D package at 8.6 mW/°C

## 8-bit multiplying D/A converter

## MC1408-8

**DC ELECTRICAL CHARACTERISTICS**

Pin 3 must be 3 V more negative than the potential to which  $R_{15}$  is returned.  $V_{CC} = +5.0 V_{DC}$ ,  $V_{EE} = -15 V_{DC}$ ,  $V_{REF}/R_{14} = 2.0 \text{ mA}$  unless otherwise specified.  $T_{amb} = 0 \text{ }^{\circ}\text{C}$  to  $75 \text{ }^{\circ}\text{C}$ , unless otherwise noted.

SYMBOL	PARAMETER	TEST CONDITIONS	MC1408-8			UNIT
			Min	Typ	Max	
$E_r$	Relative accuracy	Error relative to full-scale $I_O$ , Figure 6			$\pm 0.19$	%
$t_s$	Settling time <sup>1</sup>	To within 1/2 LSB, includes $t_{PLH}$ ; $T_{amb} = +25 \text{ }^{\circ}\text{C}$ , Figure 7		70		ns
$t_{PLH}$ $t_{PHL}$	Propagation delay time Low-to-High High-to-Low	$T_{amb} = +25 \text{ }^{\circ}\text{C}$ , Figure 7		35	100	ns
$TCI_O$	Output full-scale current drift			-20		ppm/ $^{\circ}\text{C}$
$V_{IH}$ $V_{IL}$	Digital input logic level (MSB) High Low	Figure 8	2.0		0.8	$V_{DC}$
$I_{IH}$ $I_{IL}$	Digital input current (MSB) High Low	Figure 8 $V_{IH} = 5.0 \text{ V}$ $V_{IL} = 0.8 \text{ V}$		0 -0.4	0.04 -0.8	mA
$I_{15}$	Reference input bias current	Pin 15, Figure 8		-1.0	-5.0	$\mu\text{A}$
$I_{OR}$	Output current range	Figure 8 $V_{EE} = -5.0 \text{ V}$ $V_{EE} = -7.0 \text{ V}$ to $-15 \text{ V}$	0 0	2.0 2.0	2.1 4.2	mA
$I_O$	Output current	Figure 8 $V_{REF} = 2.000 \text{ V}$ , $R_{14} = 1000 \Omega$	1.9	1.99	2.1	mA
$I_{O(min)}$	Off-state	All bits low		0	4.0	$\mu\text{A}$
$V_O$	Output voltage compliance	$E_r \leq 0.19\%$ at $T_A = +25 \text{ }^{\circ}\text{C}$ , Figure 8 $V_{EE} = -5 \text{ V}$  $V_{EE}$ below $-10 \text{ V}$		-0.6 +10 -5.5, +10	-0.55, +0.5 -5.0, +0.5	$V_{DC}$
$SR _{REF}$	Reference current slew rate	Figure 9		8.0		mA/ $\mu\text{s}$
$PSRR(-)$	Output current power supply sensitivity	$I_{REF} = 1 \text{ mA}$		0.5	2.7	$\mu\text{A/V}$
$I_{CC}$ $I_{EE}$	Power supply current Positive Negative	All bits low, Figure 8		+2.5 -6.5	+22 -13	mA
$V_{CCR}$ $V_{EER}$	Power supply voltage range Positive Negative	$T_{amb} = +25 \text{ }^{\circ}\text{C}$ , Figure 8	+4.5 -4.5	+5.0 -15	+5.5 -16.5	$V_{DC}$
$P_D$	Power dissipation	All bits low, Figure 8 $V_{EE} = -5.0 V_{DC}$ $V_{EE} = -15.0 V_{DC}$		34 110	170 305	mW

**NOTES:**

1. All bits switched.

# 8-bit multiplying D/A converter

# MC1408-8

## TYPICAL PERFORMANCE CHARACTERISTICS

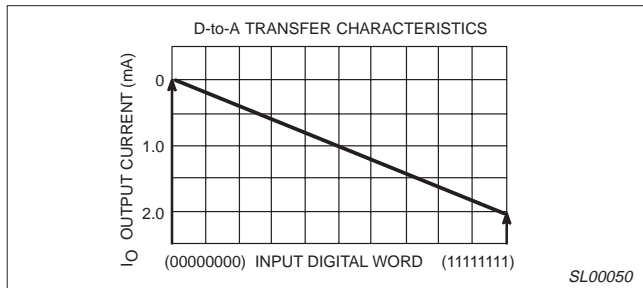


Figure 3. Typical Performance Characteristics

## FUNCTIONAL DESCRIPTION

### Reference Amplifier Drive and Compensation

The reference amplifier input current must always flow into Pin 14, regardless of the setup method or reference supply voltage polarity.

Connections for a positive reference voltage are shown in Figure 4. The reference voltage source supplies the full reference current. For bipolar reference signals, as in the multiplying mode,  $R_{15}$  can be tied to a negative voltage corresponding to the minimum input level.  $R_{15}$  may be eliminated and Pin 15 grounded, with only a small sacrifice in accuracy and temperature drift.

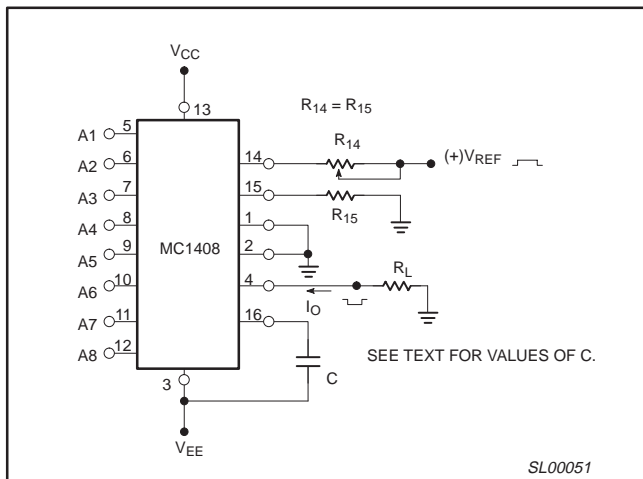


Figure 4. Positive  $V_{REF}$

The compensation capacitor value must be increased with increasing values of  $R_{14}$  to maintain proper phase margin. For  $R_{14}$  values of 1.0, 2.5, and 5.0 k $\Omega$ , minimum capacitor values are 15, 37, and 75 pF. The capacitor may be tied to either  $V_{EE}$  or ground, but using  $V_{EE}$  increases negative supply rejection. (Fluctuations in the negative supply have more effect on accuracy than do any changes in the positive supply.)

A negative reference voltage may be used if  $R_{14}$  is grounded and the reference voltage is applied to  $R_{15}$ , as shown in Figure 5. A high input impedance is the main advantage of this method. The negative reference voltage must be at least 3.0 V above the  $V_{EE}$  supply. Bipolar input signals may be handled by connecting  $R_{14}$  to a positive reference voltage equal to the peak positive input level at Pin 15.

Capacitive bypass to ground is recommended when a DC reference voltage is used. The 5.0 V logic supply is not recommended as a reference voltage, but if a well regulated 5.0 V supply which drives logic is to be used as the reference,  $R_{14}$  should be formed of two series resistors and the junction of the two resistors bypassed with 0.1  $\mu$ F to ground. For reference voltages greater than 5.0 V, a clamp diode is recommended between Pin 14 and ground.

If Pin 14 is driven by a high impedance such as a transistor current source, none of the above compensation methods apply and the amplifier must be heavily compensated, decreasing the overall bandwidth.

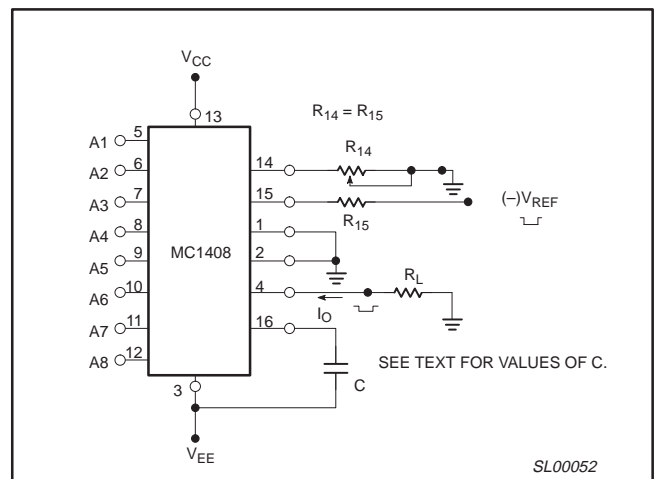


Figure 5. Negative  $V_{REF}$

### Output Voltage Range

The voltage at Pin 4 must always be at least 4.5 V more positive than the voltage of the negative supply (Pin 3) when the reference current is 2 mA or less, and at least 8 V more positive than the negative supply when the reference current is between 2 mA and 4 mA. This is necessary to avoid saturation of the output transistors, which would cause serious degradation of accuracy.

Philips Semiconductors MC1408-8 does not need a range control because the design extends the compliance range down to 4.5 V (or 8 V — see above) above the negative supply voltage without significant degradation of accuracy. Philips Semiconductors MC1408-8 can be used in sockets designed for other manufacturers' MC1408 without circuit modification.

# 8-bit multiplying D/A converter

# MC1408-8

## Output Current Range

Any time the full-scale current exceeds 2 mA, the negative supply must be at least 8 V more negative than the output voltage. This is due to the increased internal voltage drops between the negative supply and the outputs with higher reference currents.

## Accuracy

Absolute accuracy is the measure of each output current level with respect to its intended value, and is dependent upon relative accuracy, full-scale accuracy and full-scale current drift. Relative accuracy is the measure of each output current level as a fraction of the full-scale current after zero-scale current has been nulled out. The relative accuracy of the MC1408-8 is essentially constant over the operating temperature range because of the excellent temperature tracking of the monolithic resistor ladder. The reference current may drift with temperature, causing a change in the absolute accuracy of output current; however, the MC1408-8 has a very low full-scale current drift over the operating temperature range.

The MC1408-8 series is guaranteed accurate to within  $\pm 1/2$  LSB at  $+25^\circ\text{C}$  at a full-scale output current of 1.99 mA. The relative accuracy test circuit is shown in Figure 6. The 12-bit converter is calibrated to a full-scale output current of 1.99219 mA; then the MC1408-8's full-scale current is trimmed to the same value with  $R_{14}$  so that a zero value appears at the error amplifier output. The counter is activated and the error band may be displayed on the oscilloscope, detected by comparators, or stored in a peak detector.

Two 8-bit D-to-A converters may not be used to construct a 16-bit accurate D-to-A converter. 16-bit accuracy implies a total of  $\pm 1/2$  part in 65,536, or  $\pm 0.00076\%$ , which is much more accurate than the  $\pm 0.19\%$  specification of the MC1408-8.

## Monotonicity

A monotonic converter is one which always provides an analog output greater than or equal to the preceding value for a corresponding increment in the digital input code. The MC1408-8 is monotonic for all values of reference current above 0.5 mA. The recommended range for operation is a DC reference current between 0.5 mA and 4.0 mA.

## Settling Time

The worst case switching condition occurs when all bits are switched on, which corresponds to a low-to-high transition for all input bits. This time is typically 70 ns for settling to within 1/2LSB for 8-bit accuracy. This time applies when  $R_L < 500 \Omega$  and  $C_O < 25 \text{ pF}$ . The slowest single switch is the least significant bit, which typically turns on and settles in 65 ns. In applications where the D-to-A converter functions in a positive going ramp mode, the worst-case condition does not occur and settling times less than 70 ns may be realized.

Extra care must be taken in board layout since this usually is the dominant factor in satisfactory test results when measuring settling time. Short leads, 100  $\mu\text{F}$  supply bypassing for low frequencies, minimum scope lead length, good ground planes, and avoidance of ground loops are all mandatory.

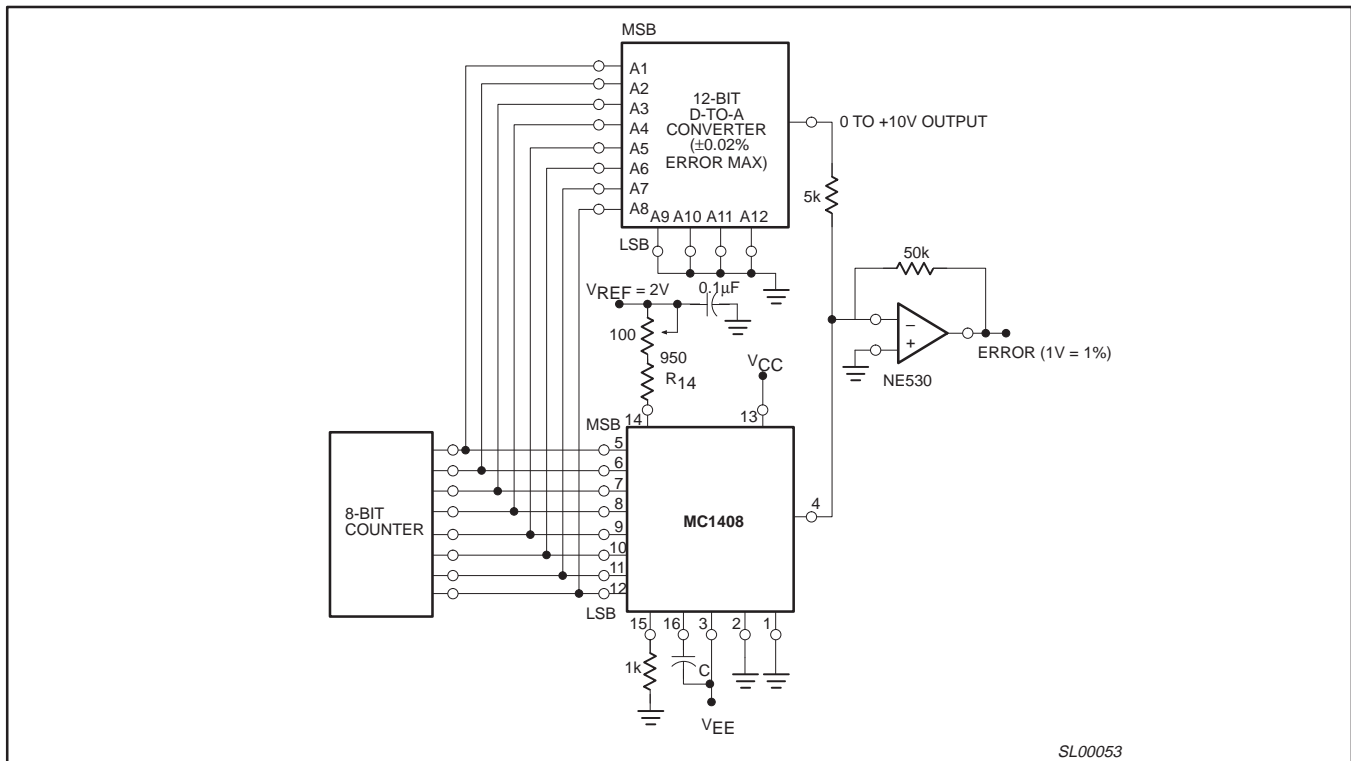


Figure 6. Relative Accuracy

# 8-bit multiplying D/A converter

# MC1408-8

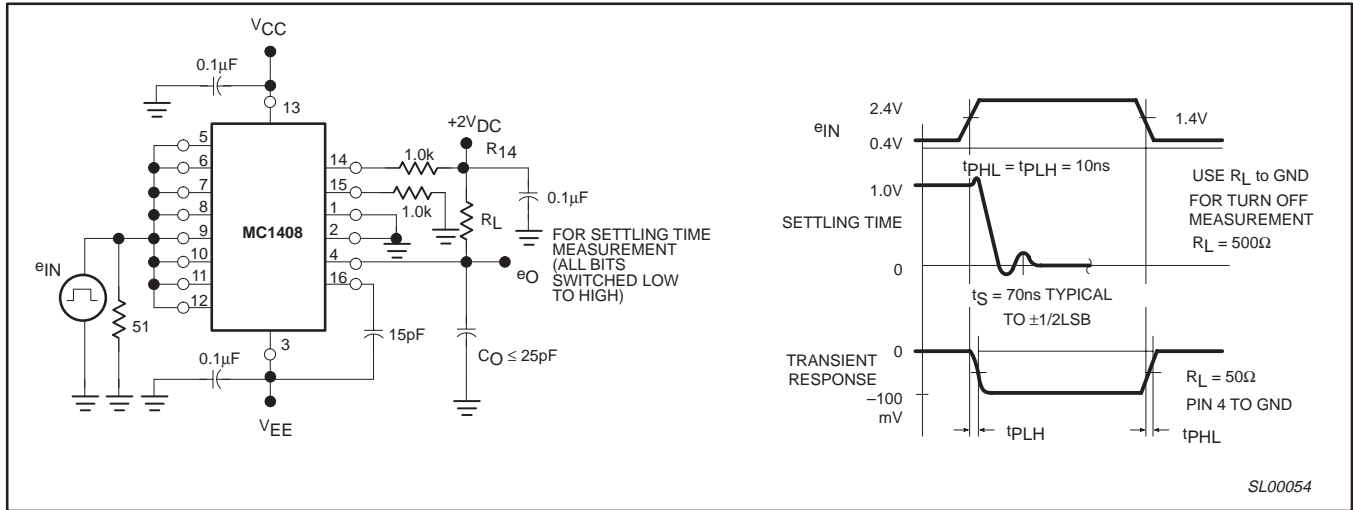


Figure 7. Transient Response and Settling Time

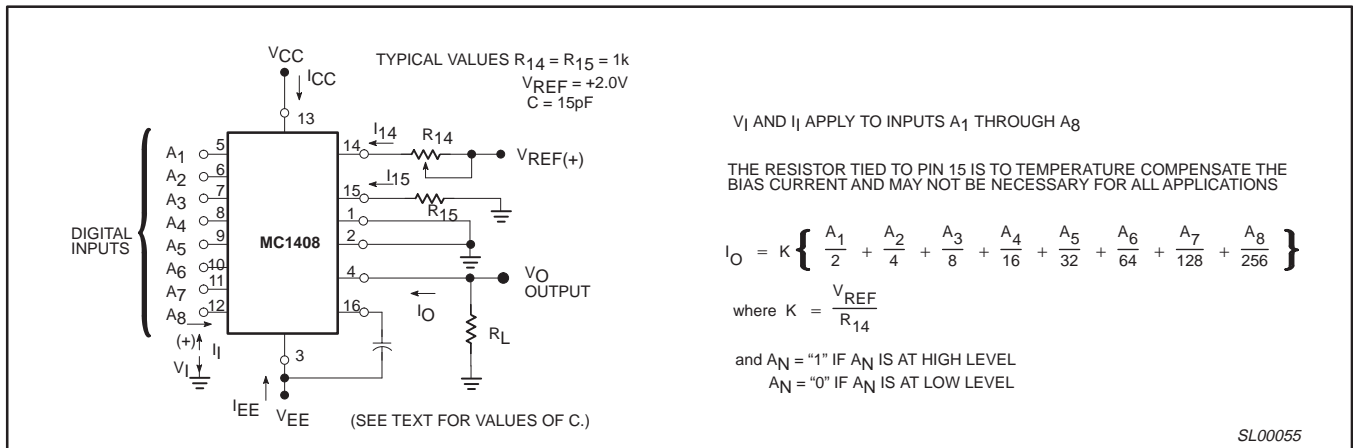


Figure 8. Notation Definitions

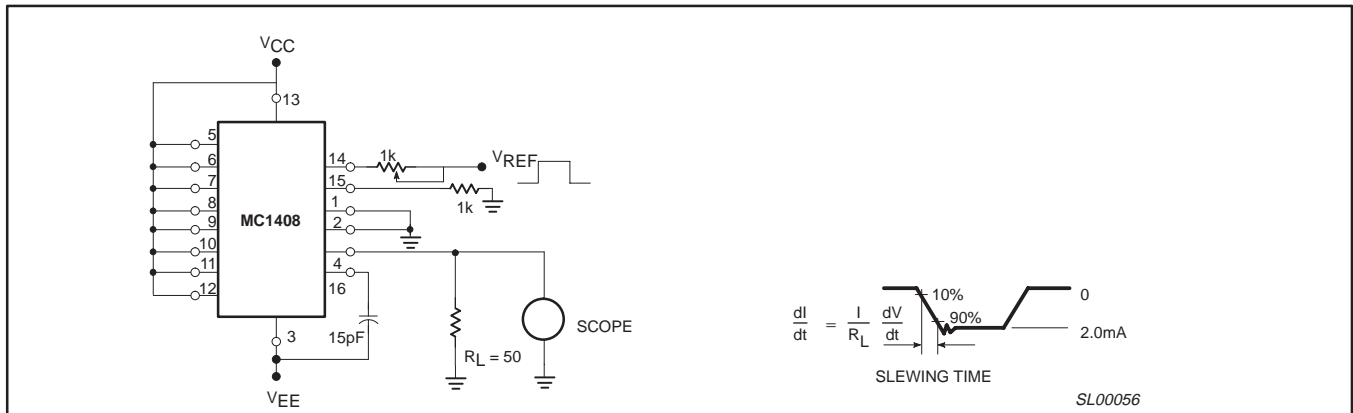


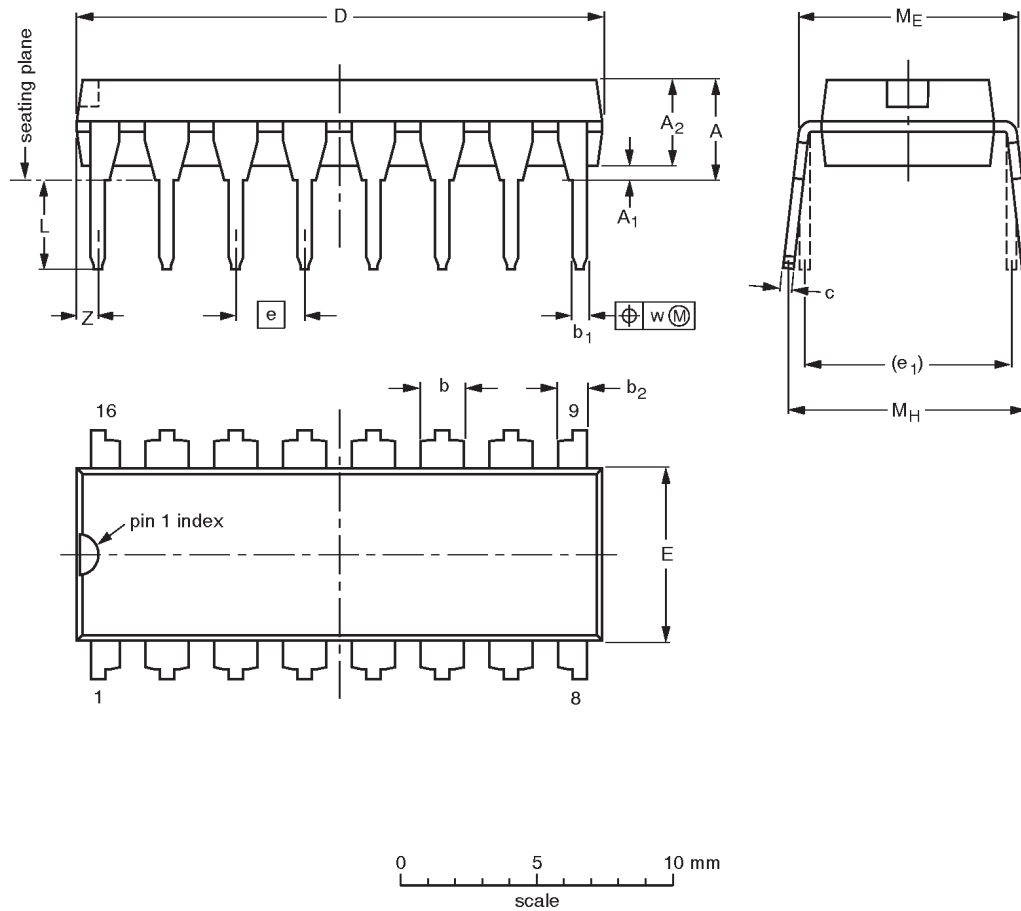
Figure 9. Reference Current Slew Rate Measurement

# 8-bit multiplying D/A converter

MC1408-8

DIP16: plastic dual in-line package; 16 leads (300 mil)

SOT38-4



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub> min.	A <sub>2</sub> max.	b	b <sub>1</sub>	b <sub>2</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	e <sub>1</sub>	L	M <sub>E</sub>	M <sub>H</sub>	w	Z <sup>(1)</sup> max.
mm	4.2	0.51	3.2	1.73 1.30	0.53 0.38	1.25 0.85	0.36 0.23	19.50 18.55	6.48 6.20	2.54	7.62	3.60 3.05	8.25 7.80	10.0 8.3	0.254	0.76
inches	0.17	0.020	0.13	0.068 0.051	0.021 0.015	0.049 0.033	0.014 0.009	0.77 0.73	0.26 0.24	0.10	0.30	0.14 0.12	0.32 0.31	0.39 0.33	0.01	0.030

**Note**

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

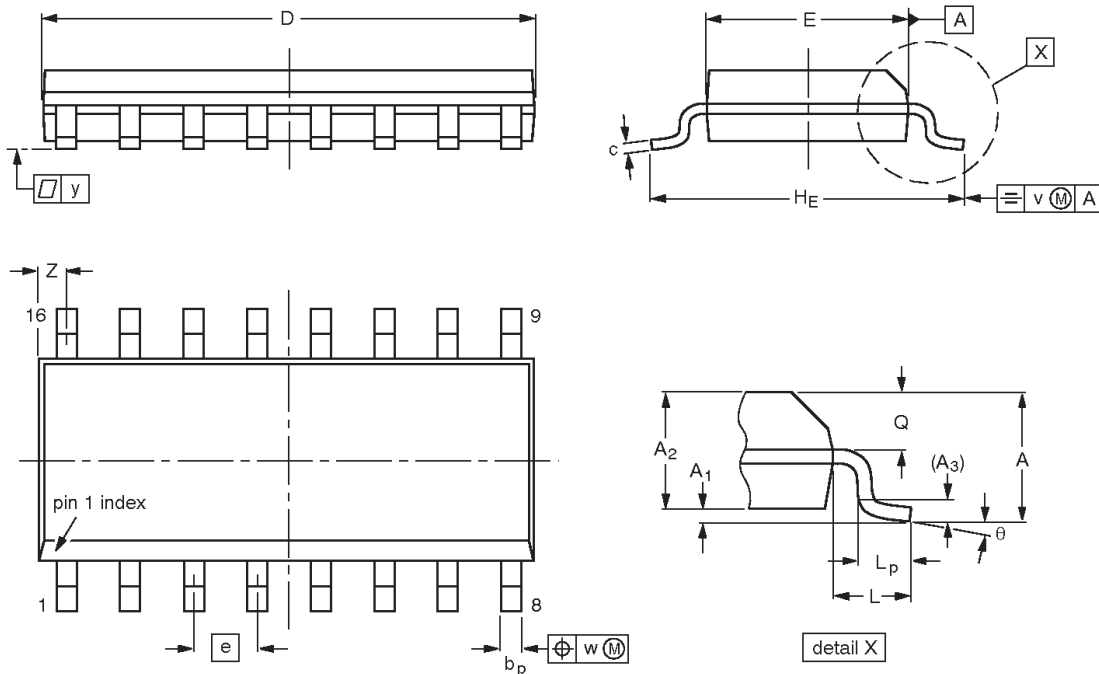
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT38-4						92-11-17 95-01-14

# 8-bit multiplying D/A converter

# MC1408-8

**SO16:** plastic small outline package; 16 leads; body width 3.9 mm

**SOT109-1**



**DIMENSIONS (inch dimensions are derived from the original mm dimensions)**

UNIT	A max.	A <sub>1</sub>	A <sub>2</sub>	A <sub>3</sub>	b <sub>p</sub>	c	D <sup>(1)</sup>	E <sup>(1)</sup>	e	H <sub>E</sub>	L	L <sub>p</sub>	Q	v	w	y	Z <sup>(1)</sup>	θ
mm	1.75	0.25 0.10	1.45 1.25	0.25	0.49 0.36	0.25 0.19	10.0 9.8	4.0 3.8	1.27	6.2 5.8	1.05	1.0 0.4	0.7 0.6	0.25	0.25	0.1	0.7 0.3	8° 0°
inches	0.069	0.010 0.004	0.057 0.049	0.01	0.019 0.014	0.0100 0.0075	0.39 0.38	0.16 0.15	0.050	0.244 0.228	0.041	0.039 0.016	0.028 0.020	0.01	0.01	0.004	0.028 0.012	

**Note**

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT109-1	076E07	MS-012				97-05-22- 99-12-27

## 8-bit multiplying D/A converter

MC1408-8

## Data sheet status

Data sheet status <sup>[1]</sup>	Product status <sup>[2]</sup>	Definitions
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
Preliminary data	Qualification	This data sheet contains data from the preliminary specification. Supplementary data will be published at a later date. Philips Semiconductors reserves the right to change the specification without notice, in order to improve the design and supply the best possible product.
Product data	Production	This data sheet contains data from the product specification. Philips Semiconductors reserves the right to make changes at any time in order to improve the design, manufacturing and supply. Changes will be communicated according to the Customer Product/Process Change Notification (CPCN) procedure SNW-SQ-650A.

[1] Please consult the most recently issued data sheet before initiating or completing a design.

[2] The product status of the device(s) described in this data sheet may have changed since this data sheet was published. The latest information is available on the Internet at URL <http://www.semiconductors.philips.com>.

## Definitions

**Short-form specification** — The data in a short-form specification is extracted from a full data sheet with the same type number and title. For detailed information see the relevant data sheet or data handbook.

**Limiting values definition** — Limiting values given are in accordance with the Absolute Maximum Rating System (IEC 60134). Stress above one or more of the limiting values may cause permanent damage to the device. These are stress ratings only and operation of the device at these or at any other conditions above those given in the Characteristics sections of the specification is not implied. Exposure to limiting values for extended periods may affect device reliability.

**Application information** — Applications that are described herein for any of these products are for illustrative purposes only. Philips Semiconductors make no representation or warranty that such applications will be suitable for the specified use without further testing or modification.

## Disclaimers

**Life support** — These products are not designed for use in life support appliances, devices or systems where malfunction of these products can reasonably be expected to result in personal injury. Philips Semiconductors customers using or selling these products for use in such applications do so at their own risk and agree to fully indemnify Philips Semiconductors for any damages resulting from such application.

**Right to make changes** — Philips Semiconductors reserves the right to make changes, without notice, in the products, including circuits, standard cells, and/or software, described or contained herein in order to improve design and/or performance. Philips Semiconductors assumes no responsibility or liability for the use of any of these products, conveys no license or title under any patent, copyright, or mask work right to these products, and makes no representations or warranties that these products are free from patent, copyright, or mask work right infringement, unless otherwise specified.

## Contact information

For additional information please visit  
<http://www.semiconductors.philips.com>. Fax: +31 40 27 24825

© Koninklijke Philips Electronics N.V. 2002  
 All rights reserved. Printed in U.S.A.

Date of release: 01-02

For sales offices addresses send e-mail to:  
[sales.addresses@www.semiconductors.philips.com](mailto:sales.addresses@www.semiconductors.philips.com)

Document order number:

9397 750 09381

*Let's make things better.*